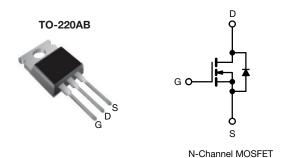
Vishay Siliconix

COMPLIANT

HALOGEN FREE

## **E Series Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> max. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.18			
Q <sub>g</sub> max. (nC)	86				
Q <sub>gs</sub> (nC)	11				
Q <sub>gd</sub> (nC)	24				
Configuration	Single				



#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qq
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>a</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	SiHP22N60E-E3			
Lead (Pb)-free and Halogen-free	SiHP22N60E-GE3			

ABSOLUTE MAXIMUM RATINGS (TC	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			$V_{DS}$	600	V
Gate-Source Voltage			$V_{GS}$	± 30	]
Continuous Prain Current (T. – 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	21	А
Continuous Drain Current (T <sub>J</sub> = 150 °C)		T <sub>C</sub> = 100 °C		13	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	56	I
Linear Derating Factor				1.8	W/°C
Single Pulse Avalanche Energy b			E <sub>AS</sub>	367	mJ
Maximum Power Dissipation			$P_{D}$	227	W
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-Source Voltage Slope $T_J = 125 ^{\circ}\text{C}$		dV/dt	70	\//	
Reverse Diode dV/dt <sup>d</sup>			11	- V/ns	
Soldering Recommendations (Peak temperature) <sup>c</sup>	for 10 s			300	°C

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 5.1 A.
- c. 1.6 mm from case.
- d.  $I_{SD} \leq I_{D}, \; dI/dt = 100 \; A/\mu s, \; starting \; T_{J} = 25 \; ^{\circ}C.$



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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	°C/W		
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.55	C/VV		

<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u			T COMPLETIONS	MIN.	T\/D	MAN	
PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static				r	1	1	
Drain-Source Breakdown Voltage	$V_{DS}$	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	$_{\circ}$ to 25 $^{\circ}$ C, $I_{D}$ = 250 $\mu$ A	-	0.71	-	V/°C
Gate-Source Threshold Voltage (N)	$V_{GS(th)}$	V <sub>DS</sub> =	$= V_{GS}, I_D = 250 \mu A$	2	-	4	V
Cata Sauraa Laakaga	I <sub>GSS</sub>	V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-Source Leakage			$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
7 0 1 1/1 5 1 0 1		V <sub>DS</sub> =	= 600 V, V <sub>GS</sub> = 0 V	-	-	1	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 11 A	-	0.15	0.18	Ω
Forward Transconductance	9fs	V <sub>D</sub>	<sub>S</sub> = 8 V, I <sub>D</sub> = 5 A	-	6.4	-	S
Dynamic				L			
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,	-	1920	-	
Output Capacitance	Coss		$V_{DS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$	-	90	-	1
Reverse Transfer Capacitance	$C_{rss}$	7	f = 1 MHz		6	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>			-	73	-	pF
Effective Output Capacitance, Time Related <sup>b</sup>	$C_{o(tr)}$	$V_{DS} = 0$	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		263	-	
Total Gate Charge	$Q_g$			-	57	86	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 11 A, V_{DS} = 480 V$	-	11	-	
Gate-Drain Charge	$Q_{gd}$	1   [		-	24	-	1
Turn-On Delay Time	t <sub>d(on)</sub>			-	18	36	
Rise Time	t <sub>r</sub>	$V_{DD} = 380 \text{ V, } I_{D} = 11 \text{ A,}$		-	27	54	ns
Turn-Off Delay Time	t <sub>d(off)</sub>		$V_{GS} = 10 \text{ V}, R_g = 4.7 \Omega$		66	99	115
Fall Time	t <sub>f</sub>				35	70	
Gate Input Resistance	$R_g$	f = 1 MHz, open drain		0.3	0.77	1.2	Ω
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21	
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	56	A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 11 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>	, , , , do		-	344	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_{\rm J} = 25$	$5 ^{\circ}\text{C},  I_{\text{F}} = I_{\text{S}} = 11 \text{A},$	-	5.3	-	μC
Reverse Recovery Current	I <sub>RRM</sub>	dl/dt = 100 A/μs, V <sub>R</sub> = 25 V			28	_	A

### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

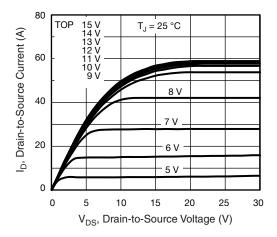


Fig. 1 - Typical Output Characteristics

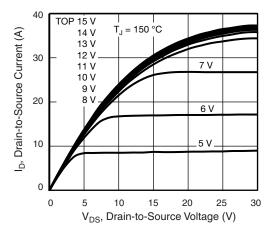


Fig. 2 - Typical Output Characteristics

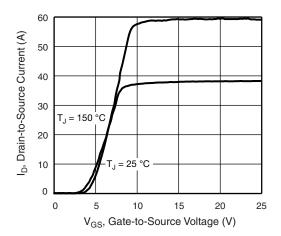


Fig. 3 - Typical Transfer Characteristics

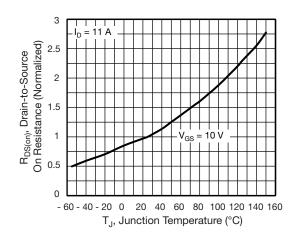


Fig. 4 - Normalized On-Resistance vs. Temperature

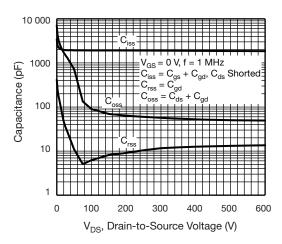


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

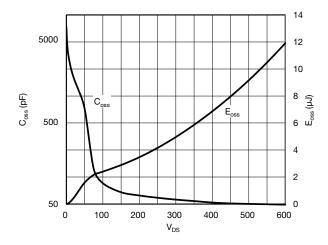


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 



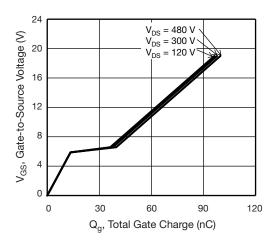


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

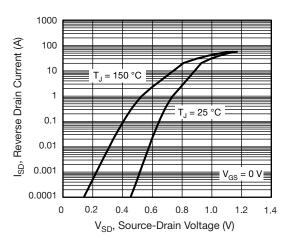


Fig. 8 - Typical Source-Drain Diode Forward Voltage

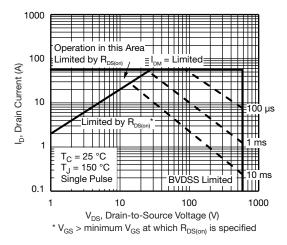


Fig. 9 - Maximum Safe Operating Area

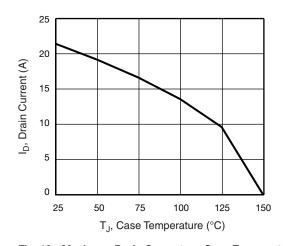


Fig. 10 - Maximum Drain Current vs. Case Temperature

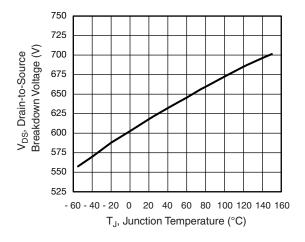


Fig. 11 - Temperature vs. Drain-to-Source Voltage



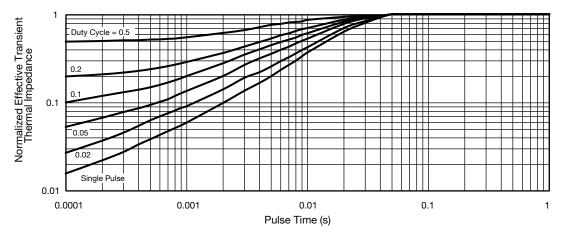


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

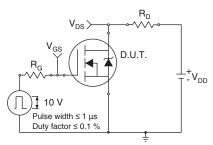


Fig. 13 - Switching Time Test Circuit

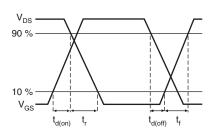


Fig. 14 - Switching Time Waveforms

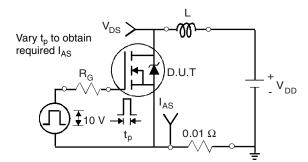


Fig. 15 - Unclamped Inductive Test Circuit

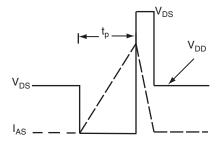


Fig. 16 - Unclamped Inductive Waveforms

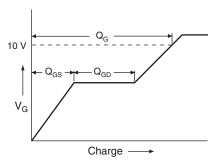


Fig. 17 - Basic Gate Charge Waveform

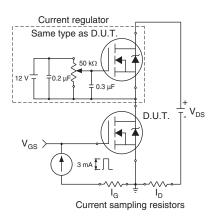
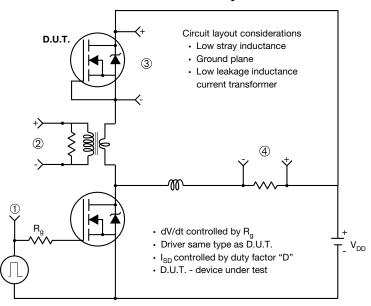


Fig. 18 - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



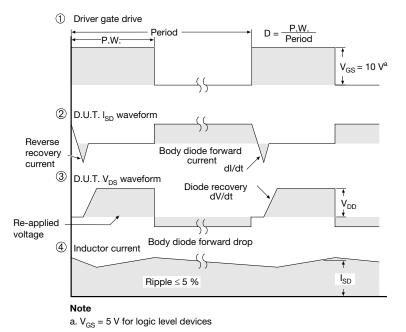
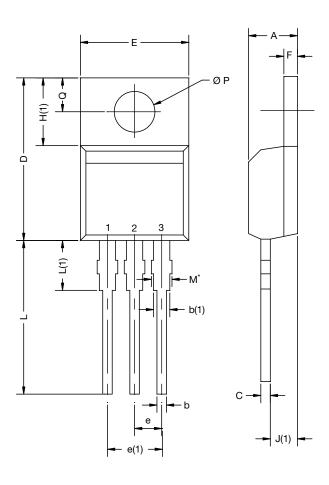


Fig. 19 - For N-Channel

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# TO-220-1



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

## Note

•  $M^* = 0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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